

ITEM NO. <u>4.23.1</u>	CRITICALITY <u>2/2</u>	SHUTTLE CCIV CRITICAL ITEMS LIST	UNIT <u>TVC/CIA</u> DNG NO. <u>2294019-506, 508/ 2294021-501</u> SHEET <u>1</u> OF <u>9</u>
FAILURE MODE AND CAUSE Time base errors (litter) in the synchronization information on the video output line. Video information is present and contains the same time base errors. IYC A1. 2294880-504 Sync generator Clock Divider Chain Phase-Locked Loop. A2. 2294881-501 Camera Timing Logic A3. 2295527-1 Master Oscillator. IYC Heaters	FAILURE EFFECT ON END ITEM (1) Loss of camera output depicting scene information within FDY of lens assembly. (2) Loss of camera until self-heating of circuitry restores normal operation. <u>Worst Case:</u> Loss of mission critical video.	DESIGN FEATURES <p>The TVC/Lens Assembly is comprised of 16 electrical subassemblies; 13 subassemblies are RCA Astro designed and fabricated using standard printed-circuit board type of construction. The remaining three assemblies, high voltage power supply, oscillator, and stepper motors, are vendor supplied components which have been specified and purchased according to RCA Specification Control Drawings (SCDs) prepared by engineering and reliability assurance. Specifications per the SCD are prepared to establish the design, performance, test, qualification, and acceptance requirements for a procured piece of equipment.</p> <p>Parts, materials, processes, and design guidelines for the Shuttle CCIV program are specified in accordance with RCA 2295503. This document defines the program requirements for selection and control of EEE parts. To the maximum extent, and consistent with availability, all parts have been selected from military specifications at the JAN level, as a minimum. In addition to the overall selection criteria, a subset of general purpose preferred parts has been defined by this document and the RCA Government Systems Division Standard Parts List. In the case of the CMOS and TTL family of microcircuits, devices are screened and tested to the MIL-STD-883C equivalent and procured under the designations of HI-REL/31Q and SMC 54LS from RCA-SSD and Texas Instruments Corp., respectively. Parts not included in the above documents have been used in the design only after a nonstandard item approval form (NSIAF) has been prepared, submitted to Reliability Assurance Engineering (RAE) and approved for use in the specific application(s) defined in the NSIAF by NASA-JSC.</p> <p>Worst-Case Circuit Analyses have been performed and documented for all circuit designs to demonstrate that sufficient operating margins exist for all operating conditions. The analysis was worst case-in that the value for each of the variable parameters was set to limits that will drive the output to a maximum (or minimum).</p> <p>A component application review and analysis was conducted to verify that the applied stress on each piece part by the temperature extremes identified with environmental qualification testing does not exceed the stress derating values identified in RCA 2295503.</p> <p>In addition, an objective examination of the design was performed through a PDA and CDR to verify that the TVC/Lens assembly met specification and contractual requirements.</p>	RATIONALE FOR ACCEPTANCE

FMEA NO. 4-2-3-1

CRITICALITY 2/2

SHUTTLE CCTV
CRITICAL ITEMS LIST

UNIT IVC/CLA
 DWG NO. 2294810-506, 508/
 2294811-503
 SHEET 2 OF 9

FAILURE MODE AND
CAUSE

Time base errors (Jitter) in the synchronization information on the video output line. Video information present and contains the same time base errors.

IVC
 A1, 2294880-504 Sync generator
 Clock Divider Chain Phase-Locked
 Loop.
 A2, 2294881-501 Camera Timing Logic
 A13, 2295521-1 Master Oscillator.

IVC Heaters

FAILURE EFFECT
ON END ITEM

- (1) Loss of camera output depicting scene information within FOV of lens assembly.
- (2) Loss of camera until self-heating of circuitry restores normal operation.
- Worst Case:
Loss of mission critical video.

RATIONALE FOR ACCEPTANCE

DESIGN FEATURES

BARE BOARD DESIGN (A1)

The design for the associated A1 board is constructed from laminated copper-clad epoxy glass sheets (NEMA G-10) Grade FR-4), PER MIL-P-55617A. Circuit connections are made through printed trace which run from point to point on the board surfaces. Every trace terminates at an annular ring. The annular ring surrounds the hole in which a component lead or terminal is located. This ring provides a footing for the solder, ensuring good mechanical and electrical performance. Its size and shape are governed by MIL-P-55610 as are trace widths, spacing and routing. These requirements are reiterated specifically in drawing notes to further assure compliance. Variations between the artwork master and the final product (due to irregularities of the etching process) are also controlled by drawing notes. This prevents making defective boards from good artwork. Holes which house no lead or terminal, but serve only to electrically interconnect the different board layers, contain stitch bars for mechanical support and increased reliability.

The thru holes are drilled from a drill tape thus eliminating the possibility of human error and allowing tight control over hole and annular ring concentricity, an important reliability criterion. After drilling and etching, All copper cladding is tin-lead plated per MIL-STD-1495. This provides for easy and reliable soldering at the time of board assembly, even after periods of prolonged storage.

BOARD ASSEMBLY DESIGN (A1)

All components are installed in a manner which assures maximum reliability. Component leads are pre-tinned, allowing total wetting of solder joints. All leads are formed to provide stress relief and the bodies of large components are slaked. Special mounting and handling instructions are included in each drawing required after final assembly. The board is coated with urethane which protects against humidity and contamination.

BOARD PLACEMENT

The A1, A2 boards are secured in the electronics assembly by gold-plated beryllium copper card guides. Connections are made to the mother board with blind-mated connectors. Disengagement during launch is prevented by a cover which spans the board's free edge.

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<p>FAILURE MODE AND CAUSE</p> <p>Time base errors (Jitter) in the synchronization information on the video output line. Video information is present and contains the same time base errors.</p> <p>IWC A1, 2294880-504 Sync generator Clock Divider Chain Phase-Locked Loop. A2, 2294811-501 Camera Timing Logic A3, 2294827-1 Master Oscillator.</p> <p>IWC Detectors</p>	<p>FAILURE EFFECT ON END ITEM</p> <p>(1) loss of camera output depicting scene information within FOV of lens assembly.</p> <p>(2) loss of camera until self-heating of circuitry restores normal operation.</p> <p>Worst Case: loss of mission critical video.</p>	<p>DESIGN FEATURES</p> <p>BARE BOARD CONSTRUCTION (A2)</p> <p>The boards are of "welded wire" construction. At the bare board level this does not distinguish it from a normal PC board except that holes which will take weld pins generally are not connected to PC traces. Only those pins which bring power and ground potentials to the ICs are on PCs. An annular ring surrounds the hole in the board where each power and ground pin is located. These pins are then soldered to the trace like any other component lead. Aside from this feature, all design & construction techniques used in PC board layout apply.</p> <p>BOARD ASSEMBLY (A2)</p> <p>The drilled and etched boards are populated with several hundred solderable or weldable pins. Power and ground pins, as well as connector pins, are soldered in place. Discrete components (resistors, diodes, capacitors) are attached to bifurcated terminals, where they are soldered. Flatpack ICs are welded, lead-by-lead, to the tops of the weld pins. After welding, extra lead material is trimmed away. Circuit connections are made using #30 AWG nickel weld wire. The wire is welded to the pin surfaces on the board backside. All wire welds are done using a machine which is tape driven, thus eliminating the possibility of miswiring due to operator error. All wiring & circuit performance is tested prior to box-level installation. After successful testing, components are staked as required by drawing notes and the assembly is coated with urethane.</p> <p>The board is inserted in the box on card-edge guides, in the same manner as the other PC boards.</p> <p>The A11 assembly is a temperature compensated voltage controlled crystal oscillator (TCVCO) that is purchased to a specification controlled drawing that establishes the requirements for performance, design, test, and qualification of the unit. The product assurance provisions of the document contain the identical requirements for electronic parts and materials as the Shuttle CCTV program and must receive the approval of RCA and NASA-JSC. Mechanical and electrical integrity of the assembly is confirmed by both analysis (design reviews) and test (qualification and acceptance).</p>

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FAILURE MODE AND CAUSE Time base errors (Jitter) in the synchronization information on the video output line. Video informa- tion present and contains the same time base errors. [WC] A1, 2294880-504 Sync generator Clock Divider Chain Phase-Locked Loop. A2, 2294881-501 Camera Timing Logic A3, 2295527-1 Master Oscillator.	FAILURE EFFECT OR END ITEM (1) Loss of camera output depicting scene information within FOV of lens assembly. (2) Loss of camera until self-heating of circuitry restores normal operation. Worst Case: Loss of mission critical video.	RATIONALE FOR ACCEPTANCE QUALIFICATION TEST For Qualification Test Flow, see Table 2 located at the front of this book.

FMEA NO. <u>4.2.3.1</u>	SHUTTLE CCTV CRITICAL ITEMS LIST	UNIT <u>TVC/CIA</u> DNG. NO. <u>2294812-506, 508Z, 2294821-503</u> SHEET <u>5</u> OF <u>9</u>
<u>FAILURE MODE AND CAUSE</u> Time base errors (Jitter) in the synchronization information on the video output line. Video information is present and contains the same time base errors. TVC A1. 2294880-504 Sync generator Clock Divider Chain Phase-Locked Loop. A2. 2294881-501 Camera Timing Logic A3. 2295577-1 Master Oscillator.	<u>FAILURE EFFECT ON CND ITEM</u> (1) Loss of camera output depicting scene information within FOV of lens assembly. (2) Loss of camera until self-heating of circuitry restores normal operation. Worst Case: Loss of mission critical video.	<u>ACCEPTANCE TEST</u> The CCTV systems' TVC/CIA is subjected directly, without vibration isolators which might be used in their normal installation, to the following testing: • Vibration: 20-80Hz; 3 dB/Oct-rise from 0.01 G ² /Hz 80-350 Hz; 0.04 G ² /Hz 350-750 Hz; -3 dB/10 Oct-slope Test Duration: 1 Minute per Axis Test Level: 6.1 Goms • Thermal Vacuum: In a pressure of 1×10^{-5} Torr, the temperature shall be as follows: 125° F: Time to stabilize equipment plus 1 hour 25° F: Time to stabilize equipment plus 1 hour 125° F: Time to stabilize equipment plus 1 hour The TVC/CIA may not have been subjected to the vacuum condition. For Acceptance Test flow, see Table I located at the front of this book.
<u>OPERATIONAL TESTS</u> In order to verify that CCTV components are operational, a test must verify the health of all the command related components from the PHS (A7A1) panel switch, through the RCU, through the sync lines to the Camera/PFU, to the Camera/PFU command decoder. The test must also verify the camera's ability to produce video, the VSU's ability to route video, and the monitor's ability to display video. A similar test would be performed to verify the MDM command path.	<u>Pre-Launch on Orbiter Test/In-flight Test</u> 1. Power CCTV System. 2. Via the PHS panel, select a monitor as destination and the camera under test as source. 3. Send "Camera Power On" command from PHS panel. 4. Select "External Sync" on monitor. 5. Observe video displayed on monitor. Note that if video on monitor is synchronized (i.e., stable raster) then this indicates that the camera is receiving composite sync from the RCU and that the camera is producing synchronized video. 6. Send Pan, Tilt, Focus, Zoom, DTR, AHD Gamma commands and visually (either via the monitor or direct observation) verify operation. 7. Select downlink as destination and camera under test as source. 8. Observe video routed to downlink. 9. Send "Camera Power Off" command via PHS panel.	

FMEA NO. 4.2.3.1		SHUTTLE CCTV CRITICAL ITEMS LIST	UNIT TVC/CLA DWG NO. 2294B39-SDG. 508/ 2294B21-503 SHEET 6 OF 9
FAILURE MODE AND CAUSE	FAILURE EFFECT ON EMIU ITEM	RATIONALE FOR ACCEPTANCE	
Time base errors (Jitter) in the synchronization information on the video output line. Video information present and contains the same time base errors.	(1) Loss of camera output depicting scene information within FOV of lens assembly. (2) Loss of camera until self-heating of circuitry restores normal operation. Worst Case: Loss of mission critical video.	QA/INSPECTION Procurement Control - The TVC/CLA EEE parts and hardware items are procured from approved vendors and suppliers, which meet the requirements set forth in the CCTV contract and Quality Plan Work Statement (HS-2593176). Resident DCAS personnel review all procurement documents to establish the need for GS1 on selected parts (PAI 517).	Incoming Inspection and Storage - Incoming Quality Inspections are made on all received materials and parts. Results are recorded by lot and retained in file by drawing and control numbers for future reference and traceability. All EEE parts are subjected to incoming acceptance tests as called for in PAI 315 - Incoming Inspection Test Instructions. Incoming flight parts are further processed in accordance with RCA 1046684 - Preconditioning and Acceptance Requirements for Electronic Parts, with the exception that DPA and PBO testing is not performed. Mechanical items are inspected per PAI 316 - Incoming Inspection Instructions for mechanical items, PAI 305 - Incoming Quality Control Inspection Instruction, and PAI 612 - Procedure for Processing Incoming or Purchased Parts Designated for Flight Use. Accepted items are delivered to Material Controlled Stores and retained under specified conditions until fabrication is required. Non-conforming materials are held for Material Review Board (MRB) disposition. (PAI-307, PAI TQC-51).
TVC A1, 2294B8H-504 Sync generator Clock Divider Chain Phase-locked Loop; A2, 2294B8I-501 Camera Timing logic A3, 2293527-1 Master Oscillator.		Board Assembly & Test - Prior to the start of TVC board assembly, all items are verified to be correct by stock room personnel, as the items are accumulated to form a kit. The items are verified again by the operator who assembles the kit by checking against the as-built-parts-list (ABPL). DCAS Mandatory Inspection Points are designated for all printed circuit, wire wrap and welded wire boards, plus harness connectors for soldering wiring, crimping, solder splices and quality workmanship prior to coating of the component side of boards and sleeving of harnesses.	TVC Boards Specific TVC board assembly and test instructions are provided in drawing notes, and applicable documents are called out in the Fabrication Procedure and Record (FPR-2294B19) and parts list PL2294B19. These include shuttle TVC assembly notes 2593B60, Process Standard RTV-566 2280881, Process Standard - Bonding Velcro Tape 2280889, Specification Soldering 2280749, Specification Name Plate Application 1960167, Specification Crimping 2280800, Specification - Bonding and Staking 2280878, Specification - urethane coating 2280B17, Specification - Locking compound 2026116, Specification Epoxy Adhesive 201090b, Specification - Marking 2280876, Specification - Workmanship 0030035, Specification - Bonding and Staking 2280875.

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FAILURE MODE AND CAUSE Time base errors (jitter) in the synchronization information on the video output line. Video information is present and contains the same time base errors. IVC AI, 2294800-504 Sync generator Clock Divider Chain Phase-Locked Loop. AI, 2294881-504 Camera Timing Logic AI, 2295523-1 Master Oscillator. IVC Heaters	FAILURE EFFECT ON END ITEM (1) Loss of camera output depicting scene information within FOV of lens assembly. (2) Loss of camera until self-heating of circuitry restores normal operation. Worst Case: Loss of mission critical video.	RATIONALE FOR ACCEPTANCE QA/INSPECTION (Continued) IVC Assembly and Test - An open box test is performed per TP-IT-2294819, and an Acceptance Test per TP-AI-2294819, including vibration and thermal vacuum. Torques are specified and witnessed, traceability numbers are recorded and calibrated tools are checked prior to use. RCA Quality and DCAS inspections are performed at the completion of specified FPR operations in accordance with PAI-204, PAI-205, PAI 206 and PAI 217. DCAS personnel witness IVC button-up and critical torquing. IVC/CLA Assembly and Test - After a TVC and an CLA have been tested individually, they are mated and a final acceptance test is performed per TP-AI-2294819, including vibration and thermal vacuum environments. RCA and DCAS personnel monitor these tests and review the acceptance test data/results. These personnel also inspect for conformance after all repair, rework and retest. Preparation for Shipment - The TVC and CLA are separated prior to shipment after fabrication and testing is complete. Each is packaged according to CECU Letter 8031 and 270074b, Process Standard for Packaging and Handling guidelines. All related documentation including assembly drawings, Parts List, ABPL, Test Data, etc., is gathered and held in a documentation folder assigned specifically to each assembly. This folder is retained for reference. An EIDP is prepared for each assembly in accordance with the requirements of HS-2591126. RCA QC and DCAS personnel witness crating, packaging, packing, and marking, and review the EIDP for completeness and accuracy.

THEA NO. <u>4.2.3.1</u>	SHUTTLE CCIV CRITICAL ITEMS LIST	UNIT <u>IVC/CLA</u> DRG NO. <u>2294819-506, 5007</u> <u>2294821-503</u> SHEET <u>0</u> OF <u>0</u>
FAILURE MODE AND CAUSE Time base errors (fitter) in the synchronization information on the video output line. Video information is present and contains the same time base errors. IVC AJ, 2294880-504 Sync generator Clock Divider Chain Phase-Locked Loop. AJ, 2294881-501 Camera Timing Logic BJ, 2295527-1 Raster Oscillator. IVC Heaters	FAILURE EFFECT ON END ITEM (1) Loss of camera output depicting scene information within FOV of Lens assembly. (2) Loss of camera until self-heating of circuitry restores normal operation. <u>Normal Case:</u> Loss of mission critical video.	FAILURE HISTORY NONE

ITEM NO. <u>4.2.3.1</u>	CRITICALITY <u>2/2</u>	FAILURE MODE AND CAUSE Time base errors (Jitter) in the synchronization information on the video output line. Video information present and contains the same time base errors.	FAILURE EFFECT ON END ISLM (1) Loss of camera output depicting scene information within FOV of lens assembly. (2) Loss of camera until self-healing of circuitry restores normal operation. Worst Case: Loss of mission critical video.	SHUTTLE CCIV CRITICAL ITEMS LIST	UNIT <u>IYC/GIA</u> DWG NO. <u>2294819-506, 508/</u> <u>2294821-501</u> SHEET <u>9</u> OF <u>9</u>
<u>OPERATIONAL EFFECTS</u>					
Loss of video. Possible loss of major mission objectives if RMS elbow is required.					
<u>CREW ACTIONS</u>					
If possible, continue RMS operations using alternative visual cues.					
<u>CREW TRAINING</u>					
Crew should be trained to use possible alternatives to CCIV.					
<u>MISSION CONSTRAINT</u>					
Where possible, procedures should be designed so they can be accomplished without CCIV.					